

SiC JFET Division

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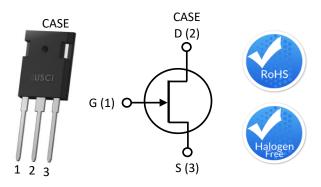


Silicon Carbide (SiC) JFET - EliteSiC, Power N-Channel, TO-247-3L, 650 V, 80 mohm UJ3N065080K3S

Datasheet

Description

United Silicon Carbide, Inc offers the high-performance G3 SiC normally-on JFET transistors. This series exhibits ultra-low on resistance ($R_{DS(ON)}$) and gate charge (Q_G) allowing for low conduction and switching loss. The device normally-on characteristics with low $R_{DS(ON)}$ at V_{GS} = 0 V is also ideal for current protection circuits without the need for active control, as well as for cascode operation.



Part Number		Package	Marking		
	UJ3N065080K3S	TO-247-3L	UJ3N065080K3S		

Features

- Typical on-resistance $R_{DS(on),typ}$ of $80m\Omega$
- Voltage controlled
- Maximum operating temperature of 175°C
- Extremely fast switching not dependent on temperature
- Low gate charge
- Low intrinsic capacitance
- RoHS compliant

Typical Applications

- Over current protection circuits
- DC-AC inverters
- Switch mode power supplies
- Power factor correction modules
- Motor drives
- Induction heating

Maximum Ratings

Parameter	Symbol	Test Conditions	Value	Units	
Drain-source voltage	V _{DS}		650	V	
Cata assumes valtage		DC	-20 to +3	V	
Gate-source voltage	V _{GS}	AC ⁽¹⁾	-20 to +20	V	
(2)	1	T _C = 25°C	32	А	
Continuous drain current (2)	I _D	T _C = 100°C	24	А	
Pulsed drain current ⁽³⁾	I _{DM}	T _C = 25°C	72	А	
Power dissipation	P _{tot}	T _C =25°C	190	W	
Maximum junction temperature	T _{J,max}		175	°C	
Operating and storage temperature	T _J , T _{STG}		-55 to 175	°C	
Max. lead temperature for soldering, 1/8" from case for 5 seconds	TL		250	°C	

- (1) +20V AC rating applies for turn-on pulses <200ns applied with external $R_G > 1\Omega$.
- (2) Limited by T_{J,max}
- (3) Pulse width t_p limited by T_{J,max}



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Electrical Characteristics (T_J = +25°C unless otherwise specified)

Typical Performance - Static

Parameter	Symbol	Test Conditions	Value			Units
raianietei	Symbol	rest conditions	Min	Тур	Max	Ullits
Drain-source breakdown voltage	BV _{DS}	V_{GS} = - 20V, I_D =1mA	650			V
Total drain leakage current	I _D	$V_{DS} = 650V$, $V_{GS} = -20V$, $T_{J} = 25$ °C		8	60	- μΑ
Total drain leakage current		$V_{DS} = 650V$, $V_{GS} = -20V$, $T_{J} = 175$ °C		30		
Total gate leakage current	1	V _{GS} =-20V, T _j =25°C		10	50	
Total gate leakage current	l _G	V _{GS} =-20V, T _j =175°C		32		μΑ
		$V_{GS}=2V, I_{D}=10A,$ $T_{J}=25^{\circ}C$		68		m0
Drain-source on-resistance	R _{DS(on)}	V_{GS} =0V, I_D =10A, T_J = 25°C		80	95	
Dialii-source oii-resistance		$V_{GS}=2V, I_{D}=10A,$ $T_{J}=175^{\circ}C$		114	- mΩ	
		V_{GS} =0V, I_{D} =10A, T_{J} = 175°C		130		
Gate threshold voltage	$V_{G(th)}$	$V_{DS} = 5V, I_{D} = 20mA$	-14	-11.5	-6	V
Gate resistance	R_{G}	f = 1MHz, open drain		3.7		Ω

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Typical Performance - Dynamic

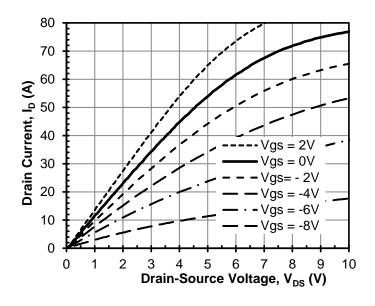
Doromotor	symbol	Test Conditions	Value			Units	
Parameter	Syllibol	rest conditions	Min	Тур	Max	Ullits	
Input capacitance	C _{iss}	V _{DS} = 100V,		630		pF	
Output capacitance	C _{oss}	V _{GS} = -20V,		94			
Reverse transfer capacitance	C _{rss}	f = 100kHz		88			
Effective output capacitance, energy related	C _{oss(er)}	$V_{DS} = 0V \text{ to } 400V,$ $V_{GS} = -20V$		69		pF	
Total gate charge	Q_{G}	1/ 400\/ 1 244		75			
Gate-drain charge	Q_{GD}	V_{DS} =400V, I_{D} = 24A,		43		nC	
Gate-source charge	Q_{GS}	V _{GS} =-18V to 0V		7			
Turn-on delay time	t _{d(on)}	V _{DS} =400V, I _D =24A, Gate Driver =-18V to 0V,		6		- ns	
Rise time	t _r			25			
Turn-off delay time	t _{d(off)}			14			
Fall time	t _f	$R_{G,EXT} = 1\Omega,$ Inductive Load,		31		1	
Turn-on energy	E _{ON}	FWD: UJ3D06510TS		149		μͿ	
Turn-off energy	E _{OFF}	T _J = 25°C		183			
Total switching energy	E _{TOTAL}			332			
Turn-on delay time	t _{d(on)}			6			
Rise time	t _r	V_{DS} =400V, I_{D} =24A, Gate Driver =-18V to 0V, $R_{G,EXT}$ = 1Ω , Inductive Load, FWD: UJ3D06510TS		24		ns	
Turn-off delay time	t _{d(off)}			14			
Fall time	t _f			14			
Turn-on energy	E _{ON}			134			
Turn-off energy	E _{OFF}	T _J = 150°C		103		μͿ	
Total switching energy	E _{TOTAL}			237			

Thermal Characteristics

Parameter	symbol	Test Conditions	Value			Units
			Min	Тур	Max	Omits
Thermal resistance, junction-to-case	$R_{\theta JC}$			0.61	0.79	°C/W



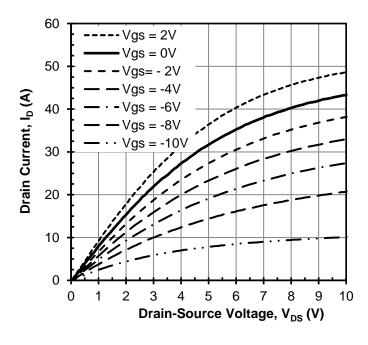
Typical Performance Diagrams

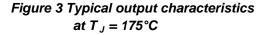


80 70 60 Drain Current, I_D (A) 50 40 Vgs = 2V Vgs = 0V30 Vgs = -2V. 20 Vgs = -4VVgs = -6V10 Vas = -8V3 5 7 8 10 6 Drain-Source Voltage, V_{DS} (V)

Figure 1 Typical output characteristics at $T_J = 55$ °C

Figure 2 Typical output characteristics at $T_J = 25$ °C





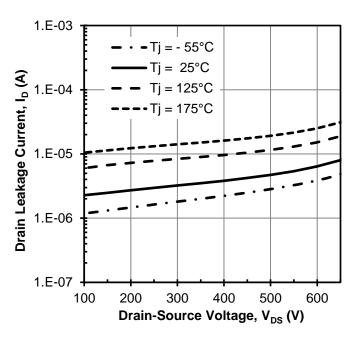


Figure 4 Typical drain-source leakage at $V_{GS} = -20V$

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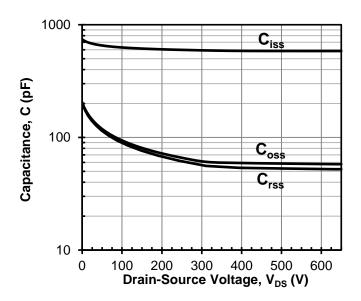


Figure 5 Typical capacitances at 100kHz and $V_{GS} = -20V$

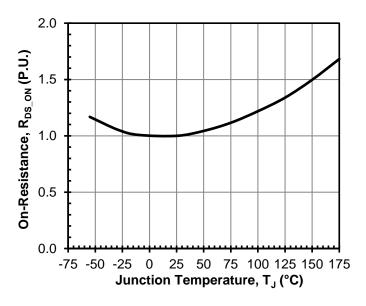


Figure 7 Normalized on-resistance vs. temperature at $V_{GS} = 0V$ and $I_D = 10A$

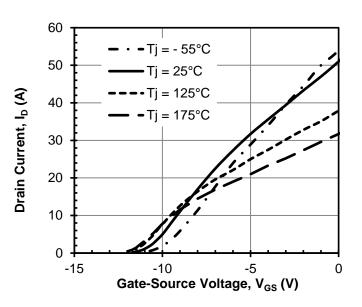


Figure 6 Typical transfer characteristics at $V_{DS} = 5V$

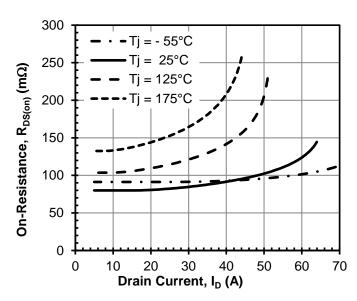


Figure 8 Typical drain-source on-resistance at $V_{GS} = 0V$

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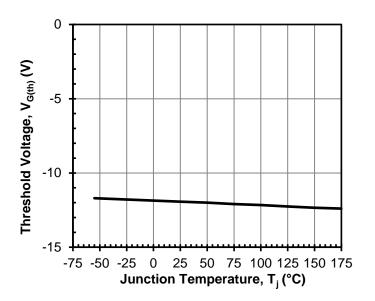


Figure 9 Threshold voltage vs. Tj at $V_{DS} = 5V$ and $I_D = 20mA$

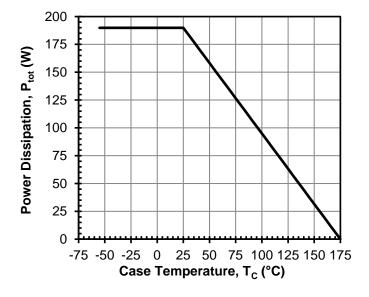


Figure 11 Total power Dissipation

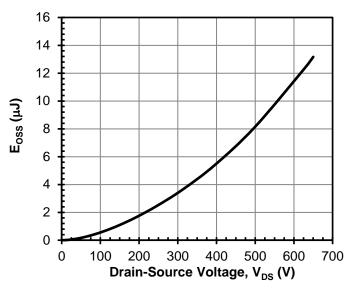


Figure 10 Typical stored energy in C_{OSS} at $V_{GS} = -20V$

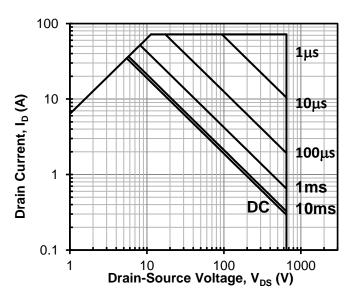


Figure 12 Safe operation area $T_c = 25$ °C, Parameter t_p

Datasheet

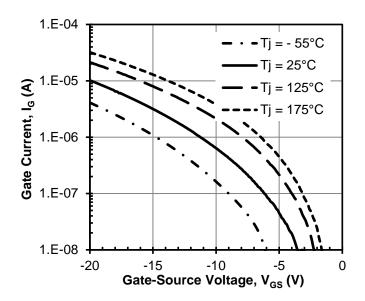


Figure 13 Typical gate leakage current at $V_{DS} = 0V$

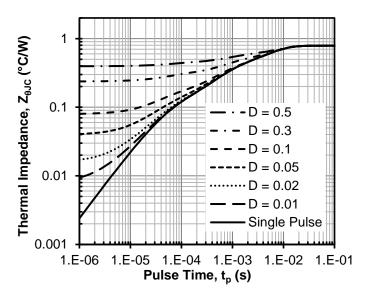


Figure 15 Maximum transient thermal impedance

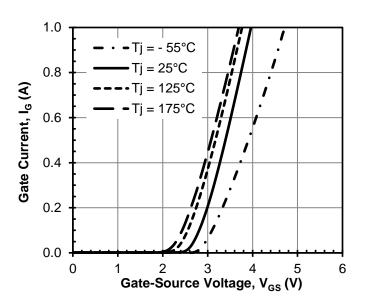


Figure 14 Typical gate forward current at $V_{DS} = 0V$

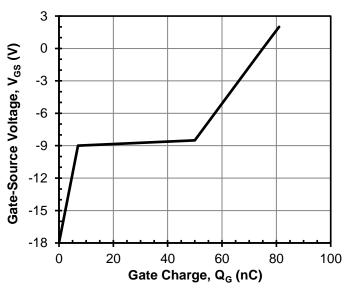
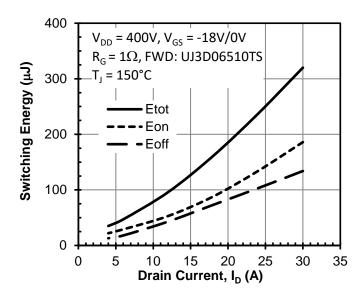


Figure 16 Typical gate charge at $V_{DS} = 400V$ and $I_D = 24A$





600 $V_{DD} = 400V$, $V_{GS} = -18V/0V$ $I_D = 24A, T_1 = 150^{\circ}C$ 500 Switching Energy (μJ) FWD: UJ3D06510TS 400 300 200 Etot Eon 100 - Eoff 0 2 4 8 10 0 Gate Resistor, $R_{G}(\Omega)$

Figure 17 Clamped inductive switching energy vs. drain current at $T_J = 150$ °C

Figure 18 Clamped inductive switching energy vs. gate resistor R_G

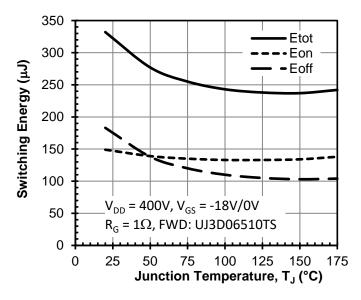


Figure 19 Clamped inductive switching energy vs. junction temperature at $I_D = 24A$

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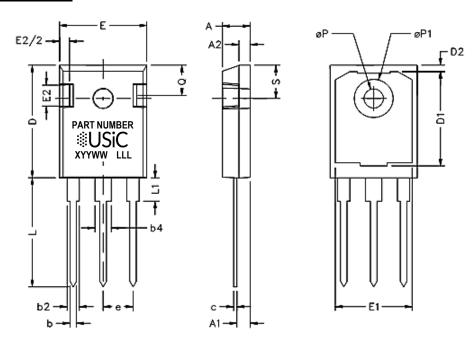
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TO-247-3L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

PACKAGE OUTLINE

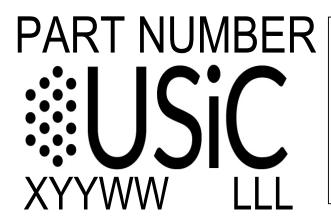


SYM	INC	HES	MILLIMETERS		
	MIN	MAX	MIN	MAX	
Α	0.185	0.209	4.699	5.309	
A1	0.087	0.102	2.21	2.61	
A2	0.059	0.098	1.499	2.489	
b	0.039	0.055	0.991	1.397	
b2	0.065	0.094	1.651	2.388	
b4	0.102	0.135	2.591	3.429	
С	0.015	0.035	0.381	0.889	
D	0.819	0.845	20.803	21.463	
D1	0.515	-	13.081	-	
D2	0.02	0.053	0.508	1.346	
E	0.61	0.64	15.494	16.256	
е	0.214	4 BSC	5.44 BSC		
E1	0.53	-	13.462	-	
E2	0.135	0.157	3.429	3.988	
L	0.78	0.8	19.812	20.32	
L1	ı	0.177	ī	4.496	
ØΡ	0.14	0.144	3.556	3.658	
ØP1	0.278	0.291	7.061	7.391	
Q	0.212	0.244	5.385	6.198	
S	0.243	3 BSC	6.17 BSC		



TO-247-3L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

PART MARKING



PART NUMBER = REFER TO
DS PN DECODER FOR DETAILS

X = ASSEMBLY SITE

YY = YEAR

WW = WORK WEEK

LLL = LOT ID

PACKING TYPE

ANTI-STATIC TUBE

QUANTITY /TUBE: 30 UNITS

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